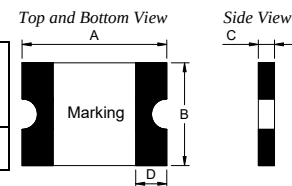


1、Physical Dimensions(size of 0805)

Unit:mm

Part Number	A		B		C		D	Marking
	Min	Max	Min	Max	Min	Max	Min	
K0805L005/60AR	2.0	2.3	1.2	1.5	0.55	0.95	0.20	



2、Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I _{max} (A)	T _{trip} (Max time to trip)		Pd _{typ} (W)	R _{min} (Ω)	R1 _{max} (Ω)
					Current(A)	Time(S)			
K0805L005/60AR	0.05	0.15	60.0	40	0.25	1.50	0.50	3.60	50.0

I_H: Holding Current: maximum current at which the device will not trip in 25°C still air.

I_T: Tripping Current minimum current at which the device will trip in 25°C still air.

V_{max}: Maximum voltage device can withstand without damage at rated current.

I_{max}: Maximum fault current device can withstand without damage at rated voltage.

T_{trip}: Maximum time to trip(s) at assigned current.

Pd_{typ}: Rated working power.

R_{min}: Minimum resistance of device prior to trip at 25°C.

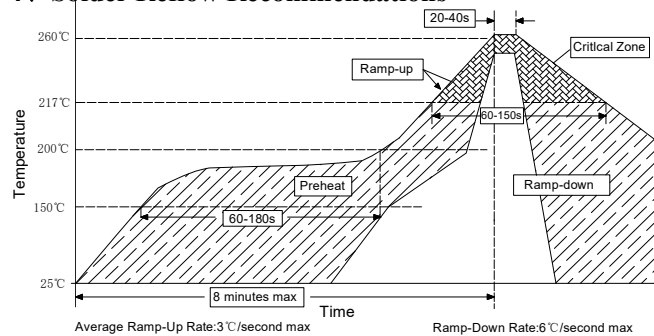
R1_{max}: Maximum resistance of device is measured one hours post reflow at 25°C.

Noted: All electrical function test is conducted after PCB mounted.

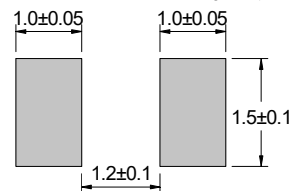
3、Thermal Derating

K0805L005/60AR	Maximum ambient operating temperature								
	-40℃	-20℃	0℃	25℃	40℃	50℃	60℃	70℃	85℃
Hold Current(A)	0.080	0.070	0.060	0.050	0.045	0.040	0.035	0.030	0.025
Trip Current(A)	0.240	0.210	0.180	0.150	0.135	0.120	0.105	0.090	0.075

4、Solder Reflow Recommendations



Recommended Pad Layout(mm)



Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5、Package Information

Packing quantity: 3500PCS/Reel

Note: Reel packaging per EIA-481-1 standard